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**Serial Number:** 10/750, 871

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## PALM INTRANET

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## **Inventor Information for 10/750871**

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US	20060608	Frequency offset estimating	375/334		Nakao; Seigo
20060120487 A1		method and frequency offset correcting apparatus utilizing			et al.
		said method			
US 20060080027 A1	20060413	Engine starting assist system	701/113		Tanaka; Yasuhiro et al.
US	20060413	Auxiliary system for starting	701/113		Tanaka;
20060080026 A1	20000113	engine			Yasuhiro et al.
US	20060413	Objective lens element and	369/44.23	369/112.23	Takano;
20060077791	20000113	optical pickup device provided	307/11.23	307/112.23	Hironari et al.
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US	20060406	External cavity type tunable	372/38.02	372/43.01	Tanaka;
20060072638 A1		laser source			Yasuhiro
US	20060406	Liquid-sealed vibration control	267/140.13		Hatakeyama;
20060071381 A1		equipment and elastic partition film for use therein			Shingo et al.
US	20060323	Adhesive and method of	156/163		Maeda; Reiko
20060060288	20000323	manufacturing image display	150,105		et al.
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US 20060044079 A1	20060302	Surface acoustic wave device	333/193		Nishizawa; Toshio et al.
US	20060202	Surface acoustic wave device	333/133		Taniguchi;
20060022767		·			Noriaki et al.
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US	20051229	Method and apparatus for	370/349		Nakao, Seigo
20050286484		transmitting signals			et al.
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US	20051222	Optical pickup lens device and	359/754		Hayashi,
20050280907		information recording and			Katano et al.
A1		reproducing device using the same			
US	20051110	Heterocyclic compounds	514/264.1	514/300;	Yamada,
20050250796				544/279; 546/122	Tatsuhiro et al.
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A1 US	20051013	Ink used in inkjet recording,	347/100		Fukuda,

A1	<u> </u>	inkjet recording head and			
111		manufacturing method therefor,			
		method for treating inkjet			
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US	20051006	Novel phenylalanine derivatives	514/227.8	514/234.2;	Sagi,
20050222141				514/266.22;	Kazuyuki et al.
A1				514/266.31;	
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US	20050915	Catalysts for polymerization or	502/118	502/103;	Yoshikiyo,
20050202958		copolymerization of alpha-		502/124;	Motozo et al.
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		thereof, and processes for		526/125.3;	
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20050164655	20030728	transmitting signals, method and	433/101		et al.
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		system utilizing the same			
US	20050728	Correlator and receiving	375/343		Nakao, Seigo
20050163264		apparatus utilizing the same			et al.
A1					
US	20050728	Solid-state imaging device and	250/208.1	250/214.1	Tanaka, Syouji
20050161584		camera			et al.
A1					
US	20050714	Method of manufacturing	438/514	257/E29.117;	Kitamura,
20050153527		semiconductor device		257/E29.147	Akio
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US	20050630	Frequency offset estimating	375/346		Tanaka,
20050141658		method and frequency offset			Yasuhiro et al.
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20050141641	20030030	apparatus with adaptive array	373/310		Yasuhiro et al.
A1		signal processing			l'asumo et al.
US	20050616	Voltage booster device having	327/536		Takagi,
20050127983	20030010	voltage booster device naving voltage-suppressing circuit	3211330		Nobutomo et
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US	20050616	Semiconductor device exhibiting	257/341	257/E21.346;	Matsuzaki,
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		same		257/E29.062;	
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US	20050609	Optical head device and optical	359/754		Tanaka,
20050122597	ı	information recording and	1	1	Yasuhiro et al.

A1		reproducing device			
US	20050526	Objective lens element for	369/112.08	369/112.23	Tanaka,
20050111336		optical disks and optical head			Yasuhiro et al.
A1		device incorporating the same			
US	20050505	Method for producing optical	264/528	264/454;	Umetani,
20050093210		element having antireflection	= 0 0 0	264/500	Makoto et al.
A1		structure, and optical element		20 ,, 200	TVIANOLO GI ALI
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		produced by the method			
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20050088746	20030428	control element and optical	333/303	333/300	Motonobu et
A1		apparatus using the same			al.
US	20050428	Press-in apparatus for Z profile	29/509	29/715	Kitamura,
20050086790	20030428	sheet pile and press-in method	29/309	29//13	Akio et al.
A1		of Z profile sheet pile			AKIO et al.
US	20050331	Phenylalanine derivatives	514/19	562/450	Tanaka,
20050070485	20030331	Frienylaianine derivatives	314/19	302/430	Yasuhiro et al.
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US US	20050303	Condition monitor system	340/438	307/10.1;	Takagi,
20050046555	20030303		340/438	340/659	· · · · ·
		responsive to different input		340/039	Nobutomo et
A1	20050210	pulses	701/26	207/10 7	al.
US	20050210	Electronic control unit having	701/36	307/10.7	Harada,
20050033494		hold circuit and method therefor			Takashi et al.
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US	20050127	Manufacturing method of a	438/534	257/E21.427;	Yamaji,
20050020040		semiconductor device		257/E29.268	Masaharu et
A1	20050105		260/110 02		al.
US	20050127	Objective lens for optical disk,	369/112.23		Tanaka,
20050018586		optical head device and optical			Yasuhiro et al.
A1		information recording and			
		reproducing apparatus using the			
		same, and mold for molding			
		lens, method for working the			
		mold for molding lens, and			
		profile measuring device for			
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		for molding lens			
US	20041125	Semiconductor integrated circuit	257/391	257/E21.544;	Kitamura,
20040232498		device and manufacture method		257/E21.618;	Akio
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				257/E21.63;	
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US	20040729	Heterocyclic compounds	514/303		Tanaka,
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US	20040729	Optical head, optical	369/112.24		Yasuda,
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			r	<del></del>	
		apparatus, computer, video			
		recording/reproducing			
		apparatus, video reproducing			
		apparatus, server and car			
		navigation system			
US	20040729	Ink used in inkjet recording,	347/100		Fukuda,
20040145640		method for inkjet recording,			Toshio et al.
A1		inkjet recording head and			
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		method for treating inkjet			
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US	20040610	Optical element, optical lens,	359/738		Komma,
20040109242		optical head apparatus, optical			Yoshiaki et al.
A1		information apparatus,			
		computer, optical information			
		medium player, car navigation			
		system, optical information			
		medium recorder, and optical			
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US	20040610	Semiconductor device	257/342	257/E29.009;	Kitamura,
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US	20040318	Semiconductor integrated circuit	257/344	257/E21.638	Kitamura,
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20030207509 A1		device and manufacture method therefore		257/E27.063	Akio
US 20030164679 A1	20030904	Organic electroluminescence element and image forming apparatus or portable terminal unit using thereof	313/504		Hamano, Takafumi et al.
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US 20030114490 A1	20030619	New phenylalanine derivatives	514/317	514/561; 514/562; 546/226; 562/426; 562/439	Tanaka, Yasuhiro et al.
US 20030035226 A1	20030220	Objective lens and optical head device	359/719		Sasano, Tomohiko et al.
US 20030012496 A1	20030116	COUPLING LENS AND SEMICONDUCTOR LASER MODULE	385/33	385/37; 385/93	YAMAGATA, MICHIHIRO et al.
US 20030001202 A1	20030102	Semiconductor device	257/330	257/E29.009; 257/E29.021; 257/E29.13; 257/E29.133; 257/E29.256; 257/E29.268	Kitamura, Akio
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US 20020196428 A1	20021226	Device for calculating diffraction efficiencies of a diffraction lens, lens with grating element, and optical system for reading	356/124	359/569; 382/286	Yamagata, Michihiro et al.
US 20020190341	20021219	Semiconductor device with a protective diode having a high	257/499	257/E29.064; 257/E29.268	Kitamura, Akio

Al		breakdown voltage			
US 20020186518 A1	20021212	Overvoltage protection circuit	361/91.1	257/E29.268	Nishikawa, Mutsuo et al.
US 20020186476 A1	20021212	Optical system for optical disk, optical head unit for optical disk, and optical drive unit	359/719	359/717; 359/718	Sasano, Tomohiko et al.
US 20020166952 A1	20021114	Beam shaper, and semiconductor laser source device and optical head using the beam shaper	250/216		Tanaka, Yasuhiro et al.
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US 20020060920 A1	20020523	Semiconductor memory with built-in cache	365/49		Tanaka, Yasuhiro et al.
US 20020003288 A1	20020110	Semiconductor apparatus and method for manufacturing the same	257/640	257/649; 257/E23.134; 257/E29.015; 438/724	Saitou, Masaru et al.
US 20010053103 A1	20011220	Semiconductor memory with built-in cache	365/207		Tanaka, Yasuhiro et al.

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US 20010026110 A1	20011004	Rotor and sealing device for rotary adsorber	310/261		Kurosawa, Masaji et al.
US 20010019046 A1	20010906	Method and apparatus for engraving	219/121.85	219/121.6	Tanaka, Yasuhiro et al.
US 20010008845 A1	20010719	Gaming machine and operation method therefor	463/25		Kusuda, Kazuhiro et al.
US 7049202 B2	20060523	Method of manufacturing semiconductor device	438/390	257/390; 257/391; 257/392; 438/372; 438/373; 438/391	Kitamura; Akio
US 7046350 B2	20060516	Device for calculating diffraction efficiencies of a diffraction lens, lens with grating element, and optical system for reading	356/124	359/569	Yamagata; Michihiro et al.
US 7020550 B2	20060328	Vehicle electronic controller	701/36	123/396; 701/29; 708/530; 714/21	Yokochi; Masaru et al.
US 6998680 B2	20060214	Semiconductor device	257/342	257/300; 257/340; 257/E29.009; 257/E29.021; 257/E29.268	Kitamura; Akio et al.
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B2		manufacturing method therefor,		•	Yasuhiro
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US 6833594 B2	20041221	Semiconductor integrated circuit device and manufacture method therefore	257/391	257/497; 257/498; 257/E21.544; 257/E21.618; 257/E21.624; 257/E21.63; 257/E21.696; 257/E27.017	Kitamura; Akio
US 6829209 B1	20041207	OBJECTIVE FOR OPTICAL DISK, OPTICAL HEAD DEVICE AND OPTICAL INFORMATION RECORDING/REPRODUCING APPARATUS BOTH COMPRISING THE SAME, MOLD FOR FORMING LENS, METHOD FOR MACHINING MOLD FOR FORMING LENS, AND SHAPE MEASURING INSTRUMENT	369/112.23		Tanaka; Yasuhiro et al
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US 6627869 B2	20030930	Beam shaper, and semiconductor laser source device and optical head using the beam shaper	250/216	359/711	Tanaka; Yasuhiro et al.
US 6610710 B2	20030826	Phenylalanine derivatives	514/330	514/331; 514/538; 514/561; 514/563; 514/567; 514/575; 544/316; 546/226; 546/245; 548/127; 560/37; 560/39; 560/40; 560/40; 560/47; 562/444; 562/445; 562/446; 562/448; 562/449; 562/621	Tanaka; Yasuhiro et al.
US 6606198 B2	20030812	Lens array	359/619		Sasano; Tomohiko et al.
US 6590717 B2	20030708	Optical system for optical disk, optical head unit for optical disk, and optical drive device	359/717	369/112.23; 398/178	Sasano; Tomohiko et al.
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B1		article for a fixation device		156/308.2;	Kazutaka et al.
				156/309.6;	
				399/328	
US 6304526	20011016	Optical head	369/44.23	369/112.24;	Nagashima;
B1				369/44.14	Kenji et al.
US 6301692	20011009	Method for designing layout of	716/10	257/E27.108;	Kumashiro;
B1		semiconductor integrated circuit,		716/2	Shinichi et al.
		semiconductor integrated circuit			
		obtained by the same method,			İ
		and method for verifying timing	]		
		thereof	1		
US 6252337	20010626	Piezoelectric resonator and	310/364	310/363	Tanaka;
B1	20010020	piezoelectric components using	310/304	310/303	Yasuhiro
DI		the same			
US 6249450	20010619	Semiconductor memory with	365/49	365/230.09	Tanaka;
B1	20010019	built-in cache	303/49	303/230.09	Yasuhiro et al.
US 6227127	20010508	ļ- <del>.</del>	110/338	110/222	
	20010308	Furnace material, heat resisting	110/338	110/323;	Yamaguchi; Shinichi et al.
B1		protection tube and protective		110/336;	Sninichi et al.
		member using the same sintered		501/100;	
		material		501/108;	
				501/110;	
TTO (15/500	20010116	26.1.1.6	100/505	501/117	75.
US 6174792	20010116	Method of manufacturing a	438/585	257/E21.427;	Kitamura;
B1		semiconductor device		257/E29.133;	Akio
				257/E29.268;	
			10 (17 10	438/425	
US 6139894	20001031	Flour blends for deep fried	426/549	426/275;	Hoshino;
A		foods, steamed Chinese manju,		426/283;	Tsuguhiro et
		dough sheets, okonomi-yaki,		426/496;	al.
		and takoyaki		426/622;	
				426/94	
US 6120191	20000919	Laser diode module	385/93	385/33;	Asakura;
A				385/37;	Hiroyuki et al.
				385/92	
US 6093461	20000725	Heat-and corrosion-resisting	428/34.4	428/213;	Yamaguchi;
A		protection tube		428/312.2;	Shinichi et al.
				428/332;	
				428/338;	
				428/34.5;	
				428/702;	
			1	501/119;	
				501/120;	
			1	501/121;	
				501/127	
US 6075276	20000613	ESD protection device using	257/481	257/199;	Kitamura;
Α		Zener diodes		257/355;	Akio
			<u> </u>	257/482;	

				257/546; 257/603; 257/606	
US 6025669 A	20000215	Piezoelectric resonator and piezoelectric components using the same	310/364	310/355	Tanaka; Yasuhiro
US 6011709 A	20000104	Semiconductor memory with built-in cache	365/49	365/230.09	Tanaka; Yasuhiro et al.
US 5989617 A	19991123	Method of assessing wheat or wheat flour regarding suitability for producing noodles	426/549	127/29; 127/32; 426/451; 426/661	Akashi; Hajime et al.
US 5986779 A	19991116	Multiple focus lens, an optical head apparatus and an optical information recording-reproducing apparatus	359/19	359/16; 359/566; 359/570; 365/216	Tanaka; Yasuhiro et al.
US 5983008 A	19991109	Method for designing layout of semiconductor integrated circuit, semiconductor integrated circuit obtained by the same method, and method for verifying timing thereof	716/6	703/19	Kumashiro; Shinichi et al.
US 5981997 A	19991109	Horizontal field effect transistor and method of manufacturing the same	257/335	257/336; 257/343; 257/E21.417; 257/E29.054; 257/E29.256	Kitamura; Akio
US 5929677 A	19990727	Phase locked loop having a voltage source responsive to a filtered phase difference output voltage and semiconductor device including the phase locked loop	327/157	327/147; 327/148; 327/156; 331/17	Murata; Toshihiko
US 5923569 A	19990713	Method for designing layout of semiconductor integrated circuit semiconductor integrated circuit obtained by the same method and method for verifying timing thereof	716/7	257/E27.108; 716/14; 716/18; 716/4	Kumashiro; Shinichi et al.
US 5917217 A	19990629	Lateral field effect transistor and method of manufacturing the same	257/343	257/339; 257/492; 257/E27.064; 257/E29.256	Kitamura; Akio et al.
US 5916619 A	19990629	Fried instant noodles and method for manufacturing the same	426/557	426/18; 426/28; 426/451; 426/555; 426/622	Miyazaki; Eiji et al.
US 5909758	19990608	Supporting tool and method of	16/406	248/205.3;	Kitamura;

A		installing same		248/205.6;	Akio
A		mstarring same		248/205.8;	AKIO
				248/206.3;	
				248/544	
US 5885878	19990323	Lateral trench MISFET and	438/302	148/DIG.126;	Fujishima;
Α		method of manufacturing the		148/DIG.151;	Naoto et al.
		same		257/E21.418;	
				257/E21.419;	
				257/E29.256;	
				257/E29.258;	
				257/E29.26;	
				438/297;	
				438/306;	
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* 10 COE 51 10	10000000		065100006	438/307	T 1
US 5875148	19990223	Semiconductor memory	365/230.06	257/E27.097;	Tanaka;
A				365/189.11	Yasuhiro et al.
US 5844275	19981201	High withstand-voltage lateral	257/335	257/336;	Kitamura;
A		MOSFET with a trench and		257/343;	Akio et al.
		method of producing the same		257/E21.417;	
				257/E29.021;	
				257/E29.256;	
				257/E29.258;	
				257/E29.268	
US 5830981	19981103	Process for producing	528/283	524/714;	Koreishi;
A 3630981	19901103	polyethylene terephthalate	J20/203	524/765;	Hiroshi et al.
A		poryemylene terephinalate		· ′	rinosin et ai.
				524/773;	
				528/274;	
				528/308.2;	
				528/308.4;	
				528/308.5;	
				528/308.6;	
				528/499;	
				528/502R;	
	,			528/503	
US 5824951	19981020	Electronic part comprising a	174/564	257/E23.193;	Tanaka;
		casing with a narrow groove		310/348;	Yasuhiro
A 1					
A					
	19980929	formed in the casing	235/494	361/728	Tanaka:
US 5814806	19980929	formed in the casing  Code sheet representing multiple	235/494		Tanaka;
	19980929	formed in the casing  Code sheet representing multiple code information and method for	235/494	361/728	Tanaka; Yasuhiro et al.
US 5814806 A		formed in the casing  Code sheet representing multiple code information and method for producing the same		361/728 235/462.01	Yasuhiro et al.
US 5814806 A US 5781466	19980929 19980714	formed in the casing Code sheet representing multiple code information and method for producing the same Semiconductor memory with	235/494	361/728 235/462.01 365/149;	Yasuhiro et al. Tanaka;
US 5814806 A US 5781466 A	19980714	formed in the casing  Code sheet representing multiple code information and method for producing the same  Semiconductor memory with built-in cache	365/49	361/728 235/462.01 365/149; 365/230.09	Yasuhiro et al.  Tanaka;  Yasuhiro et al.
US 5814806 A US 5781466 A US 5760440		formed in the casing Code sheet representing multiple code information and method for producing the same Semiconductor memory with		361/728 235/462.01 365/149; 365/230.09 257/329;	Yasuhiro et al.  Tanaka; Yasuhiro et al.  Kitamura;
US 5814806 A US 5781466 A	19980714	formed in the casing  Code sheet representing multiple code information and method for producing the same  Semiconductor memory with built-in cache	365/49	361/728 235/462.01 365/149; 365/230.09 257/329; 257/330;	Yasuhiro et al.  Tanaka;  Yasuhiro et al.
US 5814806 A US 5781466 A US 5760440	19980714	formed in the casing  Code sheet representing multiple code information and method for producing the same  Semiconductor memory with built-in cache	365/49	361/728 235/462.01 365/149; 365/230.09 257/329; 257/330; 257/334;	Yasuhiro et al.  Tanaka; Yasuhiro et al.  Kitamura;
US 5814806 A US 5781466 A US 5760440	19980714	formed in the casing  Code sheet representing multiple code information and method for producing the same  Semiconductor memory with built-in cache	365/49	361/728 235/462.01 365/149; 365/230.09 257/329; 257/330;	Yasuhiro et al.  Tanaka; Yasuhiro et al.  Kitamura;
US 5814806 A US 5781466 A US 5760440	19980714	formed in the casing  Code sheet representing multiple code information and method for producing the same  Semiconductor memory with built-in cache	365/49	361/728 235/462.01 365/149; 365/230.09 257/329; 257/330; 257/334;	Yasuhiro et al.  Tanaka; Yasuhiro et al.  Kitamura;
US 5814806 A US 5781466 A US 5760440	19980714	formed in the casing  Code sheet representing multiple code information and method for producing the same  Semiconductor memory with built-in cache	365/49	361/728 235/462.01 365/149; 365/230.09 257/329; 257/330; 257/334; 257/336;	Yasuhiro et al.  Tanaka; Yasuhiro et al.  Kitamura;

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				257/E29.021;	
		_		257/E29.256;	
		·		257/E29.26;	
				257/E29.262;	
				257/E29.267;	
				257/E29.268	
110 5757016	10000526	Plantania da incentrantan	227/156		N/
US 5757216	19980526	Electronic device using phase	327/156	327/147;	Murata;
A		synchronous circuit		331/14;	Toshihiko
				331/17	
US 5737237	19980407	Method and apparatus for data	716/9	716/8	Tanaka;
Α		path circuit layout design and			Yasuhiro et al.
		memory medium for causing			
		computer to execute data path			
		circuit layout design			
US 5705842	19980106	Horizontal MOSFET	257/362	257/281;	Kitamura;
A	17700100		2577502	257/335;	Akio et al.
А					ARIO CI al.
				257/343;	
				257/358;	
				257/360;	
				257/361;	
				257/363;	
				257/373;	
				257/379;	
				257/449;	
				257/473;	
				257/E29.258	
US 5701026	19971223	Lateral trench MISFET	257/510	257/335;	Fujishima;
A	13371223			257/374;	Naoto et al.
71				257/E21.418;	1 vaoto ot al.
				257/E21.410; 257/E21.419;	
	-			257/E21.419, 257/E29.256;	
				1	
				257/E29.258;	
				257/E29.26	
US 5684641	19971104	Objective lens and optical head	359/719	359/710;	Tanaka;
Α		apparatus using the objective		359/711;	Yasuhiro et al.
		lens		369/112.23	
US 5659258	19970819	Level shifter circuit	326/68	326/81;	Tanabe;
Α				326/83	Tetsuya et al.
US 5652727	19970729	Semiconductor memory device	365/203	365/202	Tanaka;
A					Yasuhiro et al.
US 5651006	19970722	Hierarchical network	370/408	370/902;	Fujino; Shuji
A	17770722	management system	3,0,100	709/223;	et al.
Л		management system		710/120	Ct ai.
110 6626040	10070603	F1:-:1:6	200/202	<del> </del>	Vacuus
US 5636048	19970603	Equalizing amplifier, receiver	398/202	330/278;	Kogure;
Α		using the same and preamplifier		330/291;	Kazuhisa et al.
				330/304;	
				398/208	
US 5633525	19970527	Lateral field effect transistor	257/381	257/141;	Kitamura;
00 3033323					Akio et al.

			I	257/401	<u> </u>
				257/401;	
				257/E23.015;	
				257/E29.12;	
				257/E29.268	
US 5631307	19970520	Photopolymerization initiator	522/25	522/31	Tanaka;
A		composition and			Yasuhiro et al.
		photopolymerizable composition			
US 5596521	19970121	Semiconductor memory with	365/49	365/149	Tanaka;
A		built-in cache			Yasuhiro et al.
US 5591657	19970107	Semiconductor apparatus	438/202	257/E21.417;	Fujishima;
A	133,010,	manufacturing method	1.50/202	257/E21.696;	Naoto et al.
**		employing gate side wall self-		257/E29.256;	Tradio et al.
		aligning for masking		257/E29.268;	
		angling for masking		1	
				438/208;	
			:	438/286;	
				438/305	
US 5586255	19961217	Network management operation	709/223	715/700	Tanaka;
Α		system and network			Yasuhiro et al.
		management operation method			
US 5577223	19961119	Dynamic random access	711/118	365/230.03;	Tanoi; Satoru
A		memory (DRAM) with cache		365/49;	et al.
		and tag		711/105	
US 5573888	19961112	Image transfer method	430/256	430/257;	Imabayashi;
A				430/273.1	Arata et al.
US 5566115	19961015	Semiconductor memory device	365/203	369/180;	Tanaka;
A		,		369/202;	Yasuhiro et al.
			Į	369/226	
US 5535058	19960709	Focus error detecting element	359/711	359/719	Tanaka;
A		and optical head using the same			Yasuhiro et al.
US 5523599	19960604	High voltage MIS field effect	257/327	257/335;	Fujishima;
A	19900001	transistor	2077327	257/343;	Naoto et al.
<b>''</b>		tiansistor		257/401;	Tradio di ai.
				257/653;	
				257/E29.012;	
				257/E29.012, 257/E29.027;	
				1	
				257/E29.12;	
	_			257/E29.256;	
*** - * 1 1 0 0 0	10050100		0.65/0.00	257/E29.258	
US 5511030	19960423	Semiconductor memory device	365/203	365/190	Tanaka;
		and method of driving same			Yasuhiro et al.
	100.				I I/ :4a
US 5502323	19960326	Lateral type field effect	257/335	257/341;	Kitamura;
US 5502323	19960326	Lateral type field effect transistor	257/335	257/401;	Akio et al.
US 5502323	19960326	· · · · · · · · · · · · · · · · · · ·	257/335	· ·	1
US 5502323	19960326	· · · · · · · · · · · · · · · · · · ·	257/335	257/401;	
US 5502323	19960326	· · · · · · · · · · · · · · · · · · ·	257/335	257/401; 257/E23.145;	
US 5502323	19960326	· · · · · · · · · · · · · · · · · · ·	257/335	257/401; 257/E23.145; 257/E23.152;	
US 5502323	19960326	· · · · · · · · · · · · · · · · · · ·	257/335	257/401; 257/E23.145; 257/E23.152; 257/E29.027; 257/E29.12;	1
A US 5502323 A	19960326	· · · · · · · · · · · · · · · · · · ·	257/335	257/401; 257/E23.145; 257/E23.152; 257/E29.027;	1

Α		having circuits for precharging and equalizing			Yasuhiro et al.
US 5473471 A	19951205	Complex lens with diffraction grating	359/569	359/566; 359/571; 359/574; 359/741; 359/742; 369/112.08	Yamagata; Michihiro et al.
US 5471399 A	19951128	Network management system and network status display method	716/11	370/241; 714/47; 714/57; 715/733; 715/839; 715/969; 716/8	Tanaka; Yasuhiro et al.
US 5461259 A	19951024	High-current integrated circuit	257/758	257/401; 257/776; 257/E27.06	Kitamura; Akio et al.
US 5451671 A	19950919	Method of purifying 2',3'-dideoxynucleosides	536/27.12	536/27.14; 536/28.2	Shiragami; Hiroshi et al.
US 5438665 A	19950801	Direct memory access controller for handling cyclic execution of data transfer in accordance with stored transfer control information	710/25	710/28	Taniai; Takayoshi et al.
US 5436486 A	19950725	High voltage MIS transistor and semiconductor device	257/378	257/140; 257/146; 257/577; 257/E29.064; 257/E29.197	Fujishima; Naoto et al.
US 5432370 A	19950711	High withstand voltage M I S field effect transistor and semiconductor integrated circuit	257/339	257/336; 257/337; 257/343; 257/401; 257/409; 257/E27.06; 257/E29.017; 257/E29.027; 257/E29.066; 257/E29.256; 257/E29.258	Kitamura; Akio et al.
US 5414917 A	19950516	Method of manufacturing piezoelectric resonator chips	29/25.35	310/340	Tanaka; Yasuhiro
US 5317792 A	19940607	Method of manufacturing piezoelectric resonator	29/25.35	29/411	Tanaka; Yasuhiro
US 5310895 A	19940510	Method for production of nucleoside derivatives by selective hydrolysis	536/27.14	536/103; 536/27.6; 536/27.62;	Shiragami; Hiroshi et al.

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				536/27.63;	
				536/27.81;	
				536/28.2;	
				536/28.5;	
				536/28.53;	
				1	
				536/28.54	
US 5270444	19931214	Process for treatment of	528/499	528/308.2;	Shiraki;
A		polyethylene terephthalate,		528/308.4;	Shigemi et al.
		polyethylene terephthalate for		528/308.5;	
		molding purposes and process		528/503	
		for preparation thereof			
US 5241046	19930831	Process for treatment of	528/499	528/308.2;	Shiraki;
	19930631		320/433	1	1
Α		polyethylene terephthalate,	1	528/308.4;	Shigemi et al.
		polyethylene terephthalate for		528/308.5;	
		molding purposes and process		528/503	
		for preparation thereof			
US 5213166	19930525	Pile driving and pile removing	173/1	175/65	Watanabe;
A		method			Naotaka et al.
US 5159302	19921027	Ladder type band-pass filter	333/189	310/348;	Tanaka;
A		comprising of assembled plural		310/355	Yasuhiro
71		vibrator blocks		310/333	1 asumio
TIC 5110407	10020602		710/22	<del>-</del>	Trans
US 5119487	19920602	DMA controller having	710/22		Taniai;
A		programmable logic array for			Takayoshi et
		outputting control information			al.
		required during a next transfer			
		cycle during one transfer cycle			
US 5068849	19911126	Cyclic data transmission method	370/509	370/452	Tanaka;
A		-,			Yasuhiro
US 5043935	19910827	Data transfer system for	710/66		Taniai;
	17710627		/10/00		•
A		rearranging data units using			Takayoshi et
		intermediate temporary registers			al.
US 5033017	19910716	Programmable logic array with	708/232	326/105;	Taniai;
A		reduced power consumption		326/38;	Takayoshi et
				326/44	al.
US 4998246	19910305	Method for transmission of	370/452		Tanaka;
A		cyclic data			Yasuhiro
US 4980890	19901225	Semiconductor integrated circuit	714/735		Taniai;
	17701223	Schneonauctor integrated circuit	114/133		
Α					Takayoshi et
					al.
US 4927247	19900522	Objective lens for optical disk	359/708		Tanaka;
Α		system and optical head using			Yasuhiro et al.
		the same			
US 4842388	19890627	Single optical lense with	359/718		Tanaka;
A		diffraction limit converging			Yasuhiro et al.
		capability and wide field angle			
US 4786772	19881122	Induction heating coil for heat-	219/643	210/622	I Imamata:
	19001122		219/043	219/632;	Umemoto;
A		treating metallic tubes	1	219/674;	Tadahiro et al.
	1	I	I	266/129	1

US 4695756	19870922	Laminated terminal layer for	310/355	310/326;	Tanaka;
A		electronic component		310/354;	Yasuhiro
				310/364	
US 4693571	19870915	Support and drive unit for mirror	359/874	359/877	Kimura; Sakae
Α		devices			et al.
US D291461	19870818	Reconfigurable toy vehicle	D21/582		Kitamura;
S				İ	Akio
US D290723	19870707	Reconfigurable toy vehicle	D21/581		Kitamura;
S					Akio
US D290630	19870630	Reconfigurable toy tank	D21/580		Kitamura;
S		-			Akio
US D290481	19870623	Reconfigurable toy boat	D21/580		Kitamura;
S					Akio
US 4656385	19870407	Housing having grooves therein	310/348	174/549;	Tanaka;
A		for mounting a piezoelectric		174/560;	Yasuhiro
		ladder filter		333/189	
US 4641055	19870203	Piezoelectric resonator with	310/368	310/312	Tanaka; -
A		notched sides			Yasuhiro
US 4582469	19860415	Intake valve apparatus in air	417/571	137/855	Asaka; Urataro
A		pump			et al.
US 4551074	19851105	Air pump apparatus	417/366	417/415;	Asaka; Urataro
Α				417/440;	et al.
				92/158	
US 4323865	19820406	Ladder-type piezoelectric filter	333/187	310/348;	Tanaka;
A				333/189;	Yasuhiro et al.
				333/190	